

FWS-2273

Supplier: POKI / Carton size: 340 (L)*260 (W)*75 (H) mm

Package Drop Test Report

Report NO: 17I030014



Summary	<p><input checked="" type="checkbox"/> Pass</p> <p><input type="checkbox"/> Fail Note : There is/are ___ defect(s) not list in the report, please check it in the DTS Website.</p> <p><input type="checkbox"/> Pass with Deviation</p> <p>Comment:</p>
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Issue date

2017-08-16

QE Manager

KJ Wang

Test Engineer

Jerry Chen

Test item list

1. *Test item list* ----- 2
2. *Configuration of EUT* ----- 3
3. *Package drop test* ----- 5

Testing Result

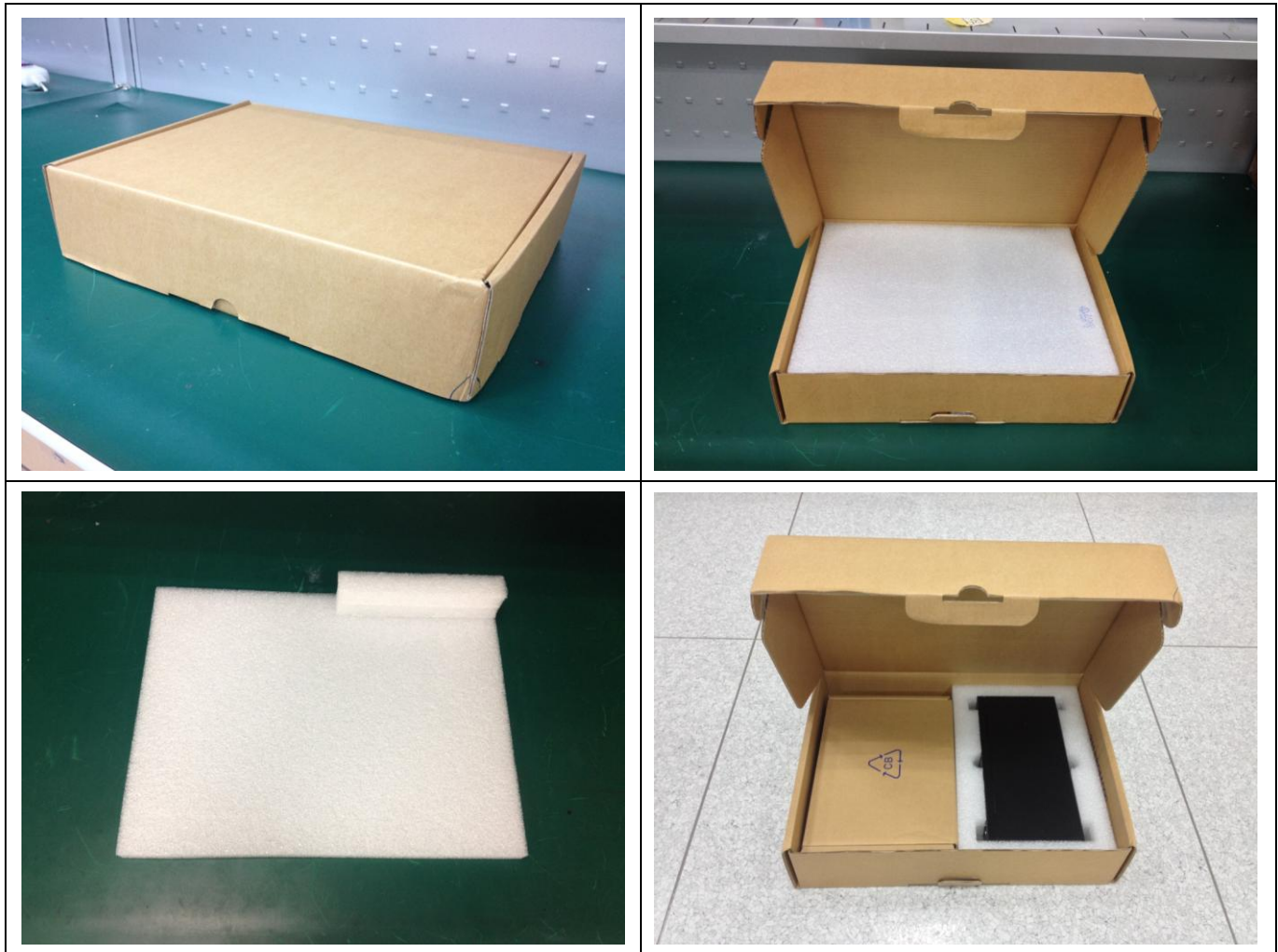
Num	Test item list	Result	Remark
1	Package drop test	Pass	

Configuration of EUT

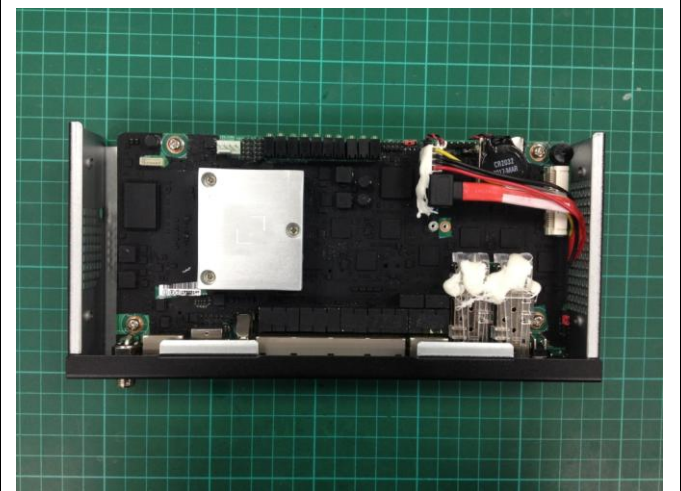
Num	Item	Device Information
1.	Model Name	FWS-2273 / Ver. A0.1
2.	M/B Name	NMB-2273 / Ver. A0.1
3.	BIOS / Version	FWS-2273 R0.1 (K273AM01) (06/30/2017)
4.	CPU Type	Intel Celeron N3350 / 1.10GHz
5.	Memory	Transcend 8GB DDR3L 1600 SO I / SEC K4B4G0846D
6.	2.5" SATA HDD	TOSHIBA 500GB / MQ01ABF050
7.	CF Card	Transcend CompactFlash CF170 / 32GB Industrial
8.	Test Software	Windows 10 / Run PassMark Burn In Test 8.1 Pro
9.	Adapter	FSP / FSP040-RHAN2 / 12V 3.33A

Photos

After Test



Package Drop Test



Package Drop Test

Test Date: 08-15-2017

Test Product: FWS-2273

Test Site: AAEON QE Dept.

Test Standard:

Reference ISTA PROJECT 1A

Test Equipment:

Drop Tester

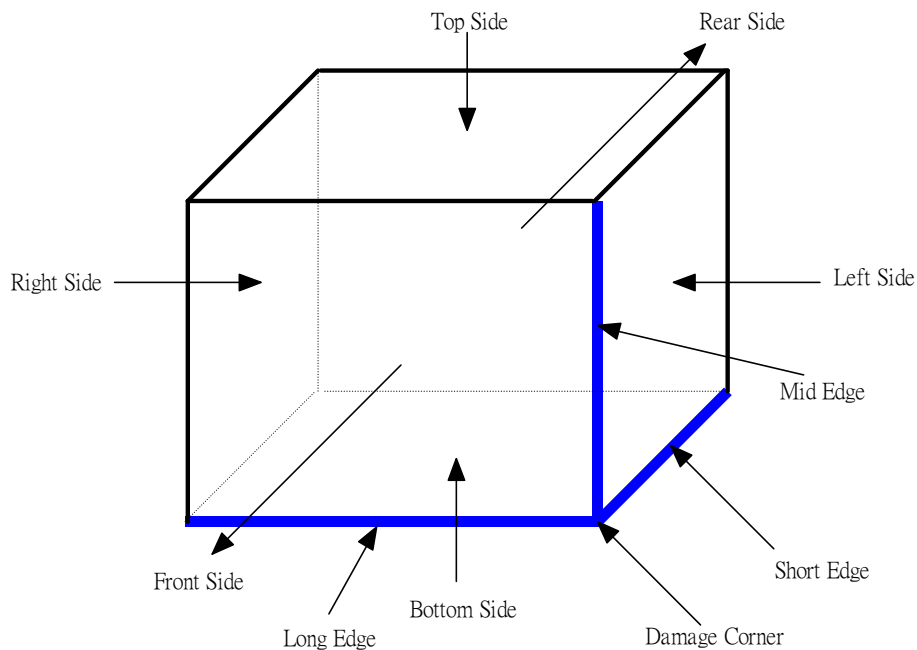
KING DESIGN Co. LTD.

Model: KD-128A

Serial Number: UU110099190

Test Condition:

1. Test Phase: One corner. Three edges. Six face
2. Test Cycle: 1 Cycle
3. Test Height: 76cm
4. Test Weight: 2.15Kg
5. Sample Package: 1unit in single-package.
6. Test Drawing:



Test Result:

The packaging is not broken, main board no structure deformation and function was working normally after the drop test.